FAIRCHILD

SEMICONDUCTOR

FDS6679AZ P-Channel PowerTrench[®] MOSFET -30V, -13A, 9mΩ

General Description

This P-Channel MOSFET is producted using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Features

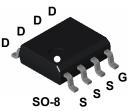
- Max $r_{DS(on)}$ = 9.3m Ω at V_{GS} = -10V, I_D = -13A
- Max r_{DS(on)} = 14.8mΩ at V_{GS} = -4.5V, I_D = -11A
- Extended V_{GS} range (-25V) for battery applications
- HBM ESD protection level of 6kV typical (note 3)
- High performance trench technology for extremely low r_{DS(on)}

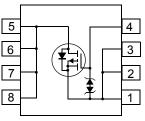
March 2009

FDS6679AZ P-Channel PowerTrench[®] MOSFET

- High power and current handing capability
- RoHS Compliant







MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		-30	V
V _{GS}	Gate to Source Voltage		±25	V
1	Drain Current -Continuous	(Note 1a)	-13	۸
D	-Pulsed		-65	— A
	Power Dissipation for Single Operation	(Note 1a)	2.5	
P _D		(Note 1b)	1.2	W
		(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Temperature		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W

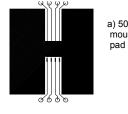
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6679AZ	FDS6679AZ	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
off Charac	teristics					
BVDSS	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-30			V
B _{VDSS}	Breakdown Voltage Temperature Coefficient	$I_D = -250\mu A$, referenced to $25^{\circ}C$		-20		mV/°C
DSS	Zero Gate Voltage Drain Current	V _{DS} = -24V, V _{GS} =0V			-1	μA
GSS	Gate to Source Leakage Current	V_{GS} = ±25V, V_{DS} =0V			±10	μA
n Charac	teristics (Note 2)					
/ _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.9	-3	V
∆V _{GS(th)}	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu A$, referenced to $25^{\circ}C$		6.5		mV/°C
		V _{GS} = -10V, I _D = -13A		7.7	9.3	
	Drain to Source On Resistance	V _{GS} = -4.5V, I _D = -11A		11.8	14.8	mΩ
DS(on)		V _{GS} = -10V, I _D = -13A, T _J = 125°C		10.7	13.4	- 11152
FS	Forward Transconductance	V _{DS} = -5V, I _D = -13A		55		S
-	Characteristics			00		0
)ynamic C	Characteristics			2890	3845	pF
ynamic C	Input Capacitance Output Capacitance	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		2890 500	665	pF pF
Dynamic C Driss Driss Driss	Input Capacitance Output Capacitance Reverse Transfer Capacitance			2890		pF
Dynamic C Diss Doss Diss Diss Diss Diss Diss Diss	Input Capacitance Output Capacitance	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		2890 500	665	pF pF
Dynamic C Diss Drss Drss Diss Diss Diss Diss Diss	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2)	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz V _{DD} = -15V, I _D = -1A		2890 500 495	665 745	pF pF pF
Dynamic C Diss Doss Drss Drss Diss Diss Diss Diss Diss Di	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		2890 500 495 13	665 745 24	pF pF pF ns
Dynamic C Diss Doss Drss Diss Diss Diss Diss Diss Diss Di	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Rise Time	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz V _{DD} = -15V, I _D = -1A		2890 500 495 13 15	665 745 24 27	pF pF pF ns ns
Dynamic C Diss Doss Drss Diss Diss Diss Diss Diss Diss Di	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Rise Time Turn-Off Delay Time	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz V _{DD} = -15V, I _D = -1A		2890 500 495 13 15 210	665 745 24 27 336	pF pF pF ns ns
ynamic C iss iss iss irss witching (on) (off)	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1MHz $V_{DD} = -15V, I_D = -1A$ $V_{GS} = -10V, R_{GS} = 6\Omega$ $V_{DS} = -15V, V_{GS} = -10V,$ I_D = -13A		2890 500 495 13 15 210 92	665 745 24 27 336 148	pF pF pF ns ns ns ns
Dynamic C Diss Doss Drss Diss D	Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1MHz $V_{DD} = -15V, I_D = -1A$ $V_{GS} = -10V, R_{GS} = 6\Omega$ $V_{DS} = -15V, V_{GS} = -10V,$		2890 500 495 13 15 210 92 68	665 745 24 27 336 148 96	pF pF pF ns ns ns ns nc

Q_{rr}

Notes:
I: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



Reverse Recovery Charge





 I_{F} = -13A, di/dt = 100A/µs

b)105°C/W when mounted on a .04 in² pad of 2 oz copper

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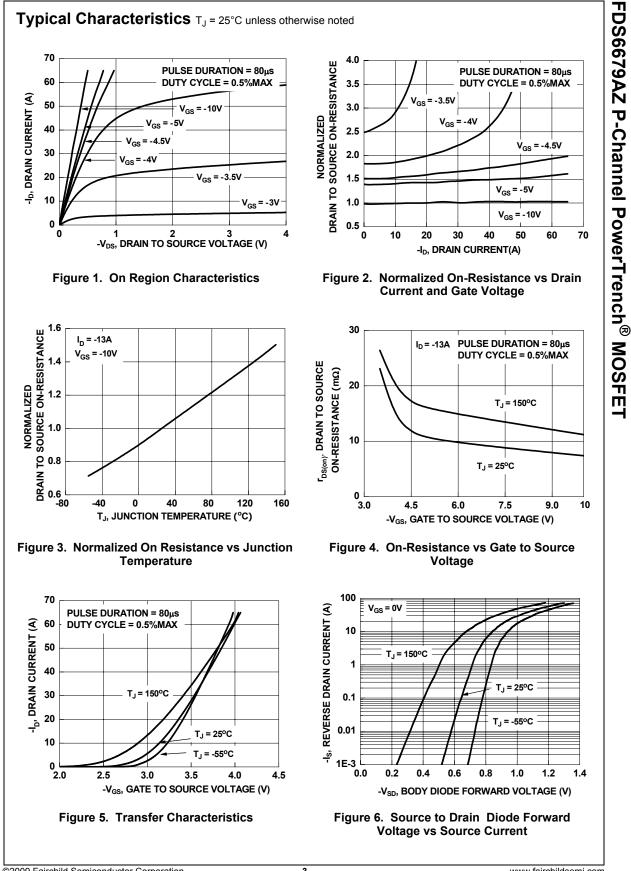
c) 125°C/W when mounted on a minimun pad

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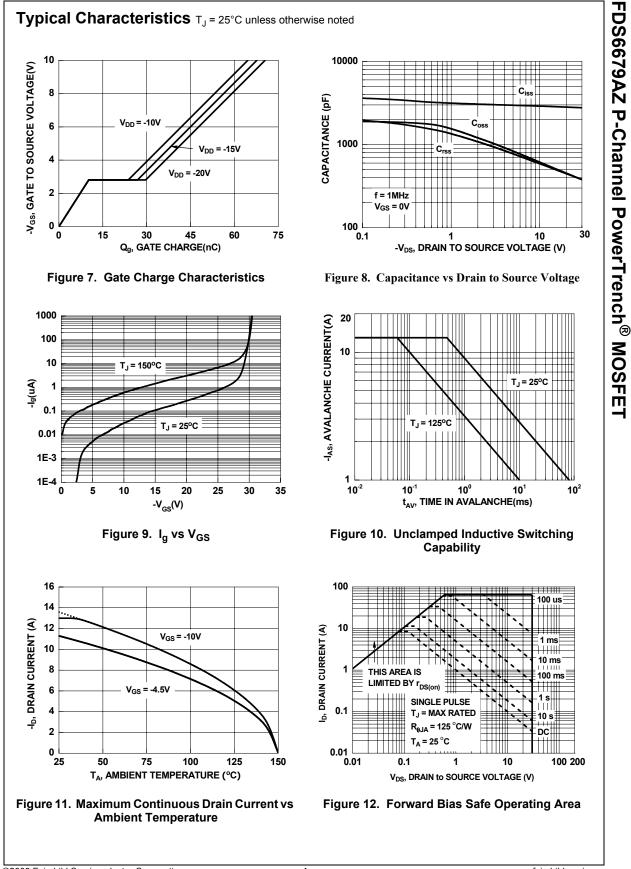
nC

Scale 1 : 1 on letter size paper

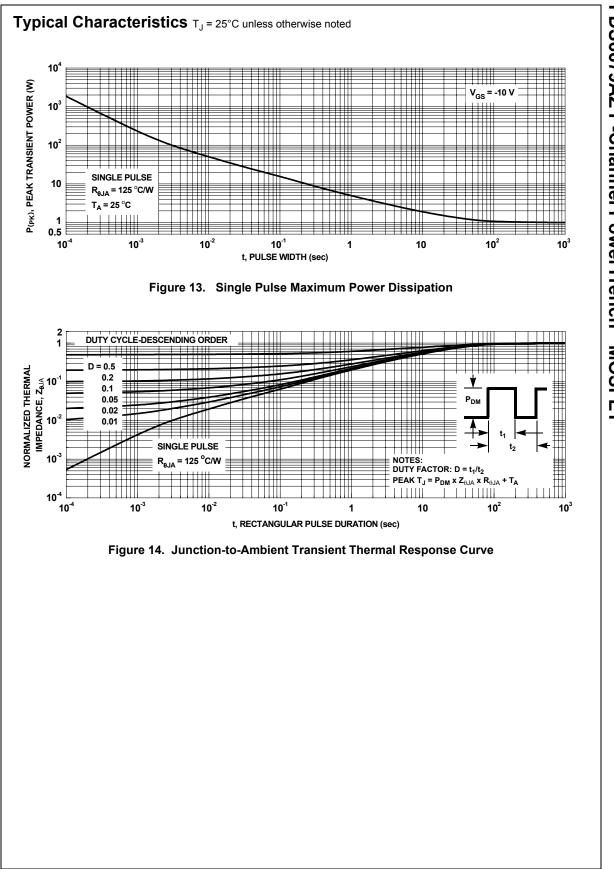
Pulse Test:Pulse Width <300μs, Duty Cycle <2.0%</li>
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



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